

SGM824 Microprocessor Supervisory Circuit with Watchdog Timer

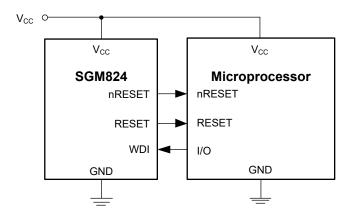
GENERAL DESCRIPTION

The SGM824 is a complete microprocessor supervisory device which combines reset and watchdog functions in a SOT-23-5 package. System reliability is significantly improved by such integration compared to the designs with individual ICs or discrete components. The SGM824 also features an excellent transient immunity to ignore fast $V_{\rm CC}$ transients.

This device has an active-low push-pull reset output (nRESET) that is activated by a watchdog expiry event or due to a low V_{CC} voltage. The nRESET output can still be in the correct logic state even if V_{CC} is lower than 1V. The SGM824 is offered in four fixed V_{CC} reset threshold voltages.

The SGM824 is available in a Green SOT-23-5 package. It operates over an ambient temperature range of -40 $^{\circ}$ C to +125 $^{\circ}$ C.

TYPICAL APPLICATION



FEATURES

- Ultra-Low Supply Current: < 1µA (TYP)
- Precision Supply-Voltage Monitor
 - + 4.63V for SGM824-L
 - 3.08V for SGM824-T
 - 2.93V for SGM824-S
 - 2.63V for SGM824-R
- Guaranteed Reset Valid at V_{cc} = 1V
- Two Reset Output Options
 - Push-Pull nRESET
 - Push-Pull RESET
- Reset Pulse Width: 200ms (TYP)
- Debounced TTL/CMOS-Compatible
- Watchdog Timer with 1.6s (TYP) Timeout
- Fully Specified over Temperature
- Power-Supply Transient Immunity
- Without External Components
- -40°C to +125°C Operating Temperature Range
- Available in a Green SOT-23-5 Package

APPLICATIONS

Computers

Portable Equipment

Automotive Equipment

Intelligent Instruments

Critical µP Power Monitoring

PACKAGE/ORDERING INFORMATION

MODEL	RESET THRESHOLD (V)	PACKAGE DESCRIPTION	ORDERING NUMBER	PACKAGE MARKING	PACKING OPTION
	4.63	SOT-23-5	SGM824-LXN5G/TR	MZ1XX	Tape and Reel, 3000
SGM824	3.08	SOT-23-5	SGM824-TXN5G/TR	MG9XX	Tape and Reel, 3000
3GIVI024	2.93	SOT-23-5	SGM824-SXN5G/TR	MGAXX	Tape and Reel, 3000
	2.63	SOT-23-5	SGM824-RXN5G/TR	MGBXX	Tape and Reel, 3000

MARKING INFORMATION

NOTE: XX = Date Code.

YYY X X

Date Code - Week

Date Code - Year

Serial Number

Green (RoHS & HSF): SG Micro Corp defines "Green" to mean Pb-Free (RoHS compatible) and free of halogen substances. If you have additional comments or questions, please contact your SGMICRO representative directly.

ABSOLUTE MAXIMUM RATINGS

Terminal Voltage (with Respect to G	ND)
V _{CC}	0.3V to 6.0V
All Other Inputs	0.3V to (V _{CC} + 0.3V)
Input Current	
V _{CC}	20mA
GND	20mA
Output Current	
All Outputs	20mA
Package Thermal Resistance	
SOT-23-5, θ _{JA}	234°C/W
Junction Temperature	+150°C
Storage Temperature Range	65°C to +150°C
Lead Temperature (Soldering, 10s).	+260°C
ESD Susceptibility	
HBM	4000V
MM	400V
CDM	1000V

RECOMMENDED OPERATING CONDITIONS

Ambient Temperature Range-40°C to +125°C

OVERSTRESS CAUTION

Stresses beyond those listed in Absolute Maximum Ratings may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect reliability. Functional operation of the device at any conditions beyond those indicated in the Recommended Operating Conditions section is not implied.

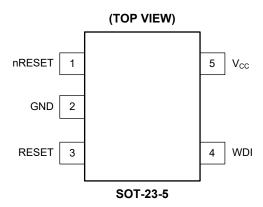
ESD SENSITIVITY CAUTION

This integrated circuit can be damaged if ESD protections are not considered carefully. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because even small parametric changes could cause the device not to meet the published specifications.

DISCLAIMER

SG Micro Corp reserves the right to make any change in circuit design, or specifications without prior notice.

PIN CONFIGURATION



PIN DESCRIPTION

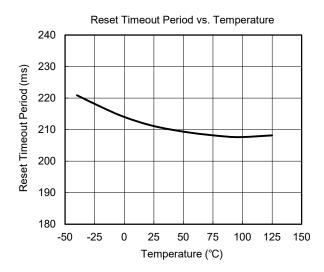
PIN	NAME	FUNCTION
1	nRESET	Active-Low Reset Output Pin. It delivers a 200ms (TYP) low pulse when activated. nRESET remains low if V_{CC} is below the reset threshold. It goes (or remains) low for 200ms after either of the following events: V_{CC} rises above the reset threshold or a watchdog expiry triggers a reset.
2	GND	Ground.
3	RESET	Active-High Reset Output Pin. It is the inverse of nRESET.
4	WDI	Watchdog Input Pin. If the high or low state of WDI exceeds the watchdog timeout period, the internal watchdog timer is expired and a reset is triggered. The internal watchdog timer is clear while a reset is asserted. The timer is also cleared if the WDI input is changed (on rising or falling edges). The watchdog feature is disabled if the WDI is left open or if it is connected to a three-stated buffer output.
5	V _{CC}	Supply Voltage Pin.

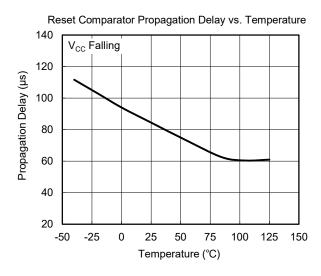
ELECTRICAL CHARACTERISTICS

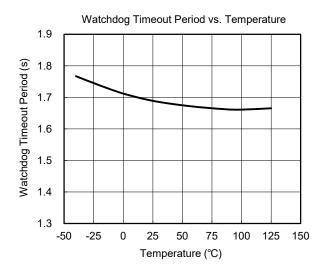
 $(T_A = +25^{\circ}C, V_{CC} = 4.73V \text{ to } 5.5V \text{ for SGM824-L}, V_{CC} = 3.14V \text{ to } 5.5V \text{ for SGM824-T}, V_{CC} = 2.99V \text{ to } 5.5V \text{ for SGM824-S}, V_{CC} = 2.68V \text{ to } 5.5V \text{ for SGM824-R}, Full = -40^{\circ}C \text{ to } +125^{\circ}C, \text{ unless otherwise noted.})$

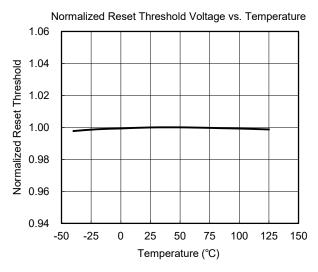
PARAMETER		CONDITIONS	TEMP	MIN	TYP	MAX	UNITS	
Operating Voltage Range (V _{CC})			Full	1		5.5	V	
Supply Current (I _{SUPPLY})		V _{CC} = 3.6V	Full		0.5	1.2		
		V _{CC} = 5.5V Full		0.7	1.4	μA		
		0011001	+25°C	4.55	4.63	4.70)	
		SGM824-L	Full	4.54	4.63	4.73	- - V	
			+25°C	3.03	3.08	3.13		
		SGM824-T	Full	3.02	3.08	3.14		
Reset Threshold (V _{RST})			+25°C	2.88	2.93	2.98		
		SGM824-S	Full	2.87	2.93	2.99	1	
			+25°C	2.59	2.63	2.67	1	
		SGM824-R	Full	2.58	2.63	2.68	1	
		SGM824-L	+25°C		20			
		SGM824-T	+25°C		14		1 .,	
Reset Threshold Hysteresis (V	HYS)	SGM824-S	+25°C		13		mV	
		SGM824-R	+25°C		12		1	
Reset Threshold Temperature Coefficient			Full		20		ppm/°C	
Reset Pulse Width (t _{RP})			Full	140	200	290	ms	
nRESET Output Voltage	V _{OH}	SGM824-L, $V_{CC} = V_{RST(MAX)}$, $I_{SOURCE} = 120\mu A$	Full	V _{CC} - 1.5				
	VOH	SGM824-T/S/R, $V_{CC} = V_{RST(MAX)}$, $I_{SOURCE} = 30\mu A$	Full	0.8 × V _{CC}			V	
		SGM824-L, $V_{CC} = V_{RST(MIN)}$, $I_{SINK} = 3.2mA$	Full			0.4		
	V _{OL}	SGM824-T/S/R, $V_{CC} = V_{RST(MIN)}$, $I_{SINK} = 1.2mA$	Full			0.3		
		$V_{CC} = 1V$, V_{CC} falling, $I_{SINK} = 50\mu A$	Full			0.3		
nRESET Output Short-Circuit	Current	SGM824-L, nRESET = 0V, $V_{CC} = 5.5V$	Full			460		
nRESET Output Short-Circuit Current (I _{SOURCE})		SGM824-T/S/R, nRESET = 0V, $V_{CC} = 3.6V$	Full			430	μА	
	V _{OH}	V _{CC} > 1.8V, I _{SOURCE} = 150μA	Full	0.8 × V _{CC}				
RESET Output Voltage	V _{OL}	SGM824-L, $V_{CC} = V_{RST(MAX)}$, $I_{SINK} = 3.2mA$	Full			0.4	V	
V _{OL}		SGM824-T/S/R, $V_{CC} = V_{RST(MAX)}$, $I_{SINK} = 1.2mA$	Full			0.3		
V _{CC} to Reset Delay (t _{RD})		V _{RST} - V _{CC} = 100mV	+25°C		84		μs	
Watchdog Timeout Period (t_{WD})			Full	1.1	1.6	2.4	sec	
WDI Pulse Width (t _{WP})		$V_{IL} = 0V$, $V_{IH} = V_{CC}$	Full	90			ns	
	Low	V _{CC} = 5V	Full			0.8	V	
WDI Input Threshold	High	V _{CC} = 5V	Full	3.5				
יייי ווויףענ דווופאווטוע	Low	V _{RST(MAX)} < V _{CC} < 3.6V	Full			0.8	0.8	
	High	V _{RST(MAX)} < V _{CC} < 3.6V	Full	0.7 × V _{CC}				
WDI Input Current		WDI = V _{CC} , time average	Full		0.02	0.5	Δ	
WDI Input Current		WDI = 0V, time average	Full	-0.5	-0.01		μA	

TYPICAL PERFORMANCE CHARACTERISTICS

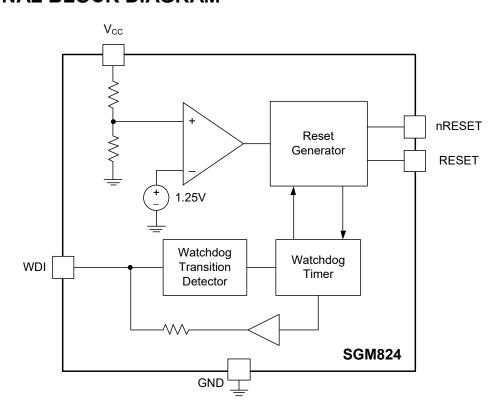








FUNCTIONAL BLOCK DIAGRAM



DETAILED DESCRIPTION

Reset Output

The reset input of a microprocessor (μP) initiates it to a known state. The SGM824 supervisory circuit asserts a reset to the supervised μP to prevent the code-execution errors that may occur due to power-up, power-down, brownout conditions or other transients. The nRESET output is still in the correct logic state even if V_{CC} is lower than 1V. During power-up, when V_{CC} exceeds the rising threshold voltage ($V_{RST} + V_{HYS}$), an internal timer keeps nRESET in low state for the reset timeout period (t_{RP}) before nRESET returns to the high state (Figure 1).

If V_{CC} drops below the falling threshold voltage (V_{RST}) (a brownout condition occurs), a reset is asserted and nRESET goes low. In general, nRESET remains low for the t_{RP} (200ms, TYP) period every time after the last event. So, if during the low period of nRESET, V_{CC} goes up and dips below V_{RST} again, the internal timer will restart for a new t_{RP} period. The nRESET output can source and sink current. The RESET function is the inverse of nRESET.

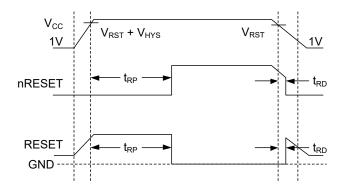


Figure 1. Reset Timing Diagram

Watchdog Input

The internal watchdog circuit monitors the μP 's activity by checking the WDI input. If the μP does not toggle the WDI within the watchdog t_{WD} (1.6s, TYP) period, the reset output will send a low pulse to reset the μP . So, the code should be written such that successive toggles on WDI occur in periods not longer than the lowest t_{WD} time to reset the internal watchdog timer and prevent μP reset when the code is running normally. The watchdog timer is cleared by either toggling WDI or by a pulse with a duration as short as 90ns. While the reset is asserted, the watchdog timer is cleared and timer does not count. It starts counting when the reset is released (Figure 2).

To disable the watchdog function, leave the WDI pin open. If WDI is driven by a 3-state buffer, set it to the Hi-Z state. In this case the buffer leakage current should not exceed 10µA. The maximum capacitance seen on the WDI pin should be less than 200pF to assure that watchdog remains disabled. The watchdog input is internally oscillating when it is left open to clear the watchdog timer and prevent it from generating a reset. It is driven low during the first 7/8 of the watchdog timeout period and driven high in the last 1/8 of that. For example if WDI input is open and the watchdog timeout is 1.6s, the watchdog timer will automatically clear every 1.4s and reset will not occur.

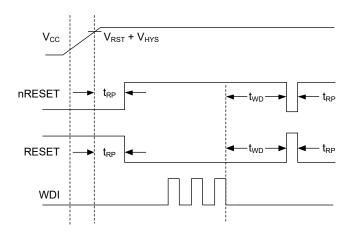


Figure 2. Watchdog Timing Relationship

APPLICATION INFORMATION

Using SGM824 with Microprocessors with Bidirectional Reset Pins

Some microprocessors can internally force their reset pins low to assert a reset (bidirectional reset pins). The low pull-up current of the SGM824 allows using of them along with the microprocessors with bidirectional resets like the 68HC11. The microprocessor can force nRESET low when nRESET is pulled high by the SGM824 with no issues (Figure 3).

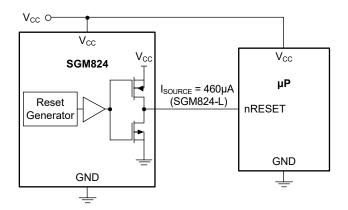


Figure 3. Interfacing to µP with Bidirectional Resets

Negative-Going Vcc Transient Immunity

The SGM824 has the ability to immune short time and negative V_{CC} transients or even glitches. It does not need to shut down the entire system. Resets are applied to the microprocessor during power-up, power-down and brownout conditions and not when an insignificant V_{CC} transient occurs.

A $0.1\mu F$ ceramic capacitor is recommended between the V_{CC} and GND pin to reduce the input supply noise.

Watchdog Input Current

The WDI input is internally driven by a buffer and series resistor from an internal counter chain stage of the watchdog. Therefore, when WDI is open, the watchdog timer is automatically cleared before timeout (by an internal low-high-low pulse).

To get the minimum WDI input current (minimum power loss), keep WDI low for the majority of the timeout period and send a high pulse at the first 7/8 of the timeout period for clearing the watchdog timer.

Watchdog Software Considerations

To have a more effective watchdog in software monitoring, rather than generating pulses by a code segment, set and reset the WDI input at different points of the program code. For example, set it in the main program and reset it in a periodic timing interrupt. For example if WDI is toggled within an unwanted infinite loop, it will continuously reset watchdog as a normal condition and the processor is not reset.

An example of a watchdog flow is shown in Figure 4. The WDI is set high at the start of the program, and is set low at the start of every subroutine or loop, then is set high again when the program returns to the start. If the processor hangs in any subroutine, the WDI toggling will not occur and the watchdog will reset the processor and correct the situation.

The reset output may also be connected to an interrupt input of the μP for a corrective action if preferred.

Note that such watchdog control schemes may not be optimal if the total power consumption is critical as discussed in the watchdog input current section.

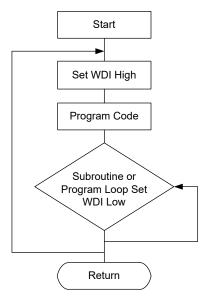


Figure 4. Watchdog Flow Diagram

SGM824

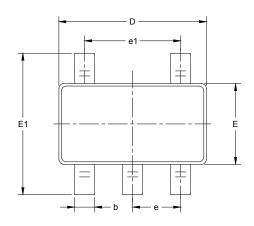
REVISION HISTORY

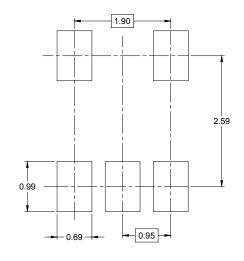
NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

JULY 2022 - REV.A.2 to REV.A.3	Page
Updated General Description section	1
Updated Detailed Description section	7
Updated Application Information section	8
JULY 2020 – REV.A.1 to REV.A.2	Page
Updated Features section	1
Changed Detailed Description section	7
JANUARY 2020 – REV.A to REV.A.1	Page
Changed Electrical Characteristics section	
Changed Typical Performance Characteristics section	5
Changed Figure 1	
Changes from Original (DECEMBER 2018) to REV.A	Page
Changed from product preview to production data	All

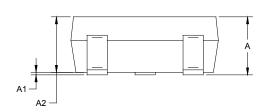


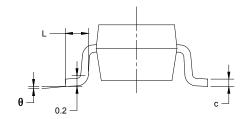
PACKAGE OUTLINE DIMENSIONS SOT-23-5





RECOMMENDED LAND PATTERN (Unit: mm)

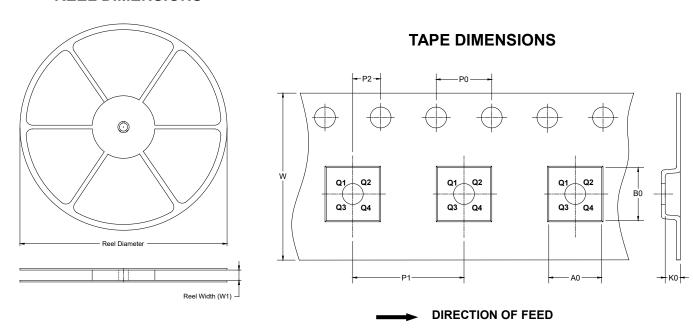




Symbol	-	nsions meters	Dimensions In Inches		
	MIN	MAX	MIN	MAX	
Α	1.050	1.250	0.041	0.049	
A1	0.000	0.100	0.000	0.004	
A2	1.050	1.150	0.041	0.045	
b	0.300	0.500	0.012	0.020	
С	0.100	0.200	0.004	800.0	
D	2.820	3.020	0.111	0.119	
Е	1.500	1.700	0.059	0.067	
E1	2.650	2.950	0.104	0.116	
е	0.950 BSC		0.037 BSC		
e1	1.900 BSC		0.075	BSC	
L	0.300	0.600	0.012	0.024	
θ	0°	8°	0°	8°	

TAPE AND REEL INFORMATION

REEL DIMENSIONS

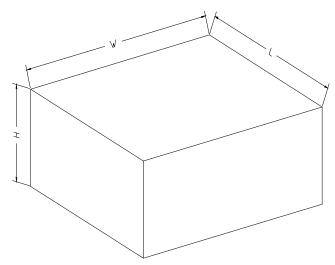


NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
SOT-23-5	7"	9.5	3.20	3.20	1.40	4.0	4.0	2.0	8.0	Q3

CARTON BOX DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF CARTON BOX

Reel Type	Length (mm)	Width (mm)	Height (mm)	Pizza/Carton
7" (Option)	368	227	224	8
7"	442	410	224	18

单击下面可查看定价,库存,交付和生命周期等信息

>>SGMICRO(圣邦微电子)